

AP43781

### USB PD CONTROLLER SUPPORTING DISPLAYPORT OVER TYPE-C ALTERNATE MODE

### **Description**

The AP43781 is a highly integrated USB Type-C<sup>®</sup> power delivery controller targeted for monitor or TV power board with USB Type-C ports. It supports USB power delivery specification Rev3.1 SPR (Standard Power Range) with full range of programmable power supply (PPS).

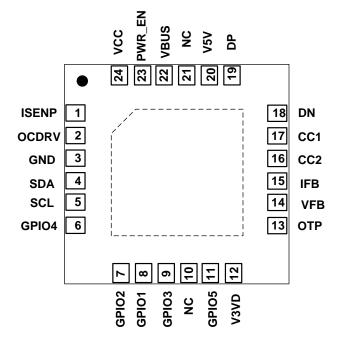
The AP43781 can support PPS APDO (Augmented Power Data Object) with resolution of 20mV/step in voltage and 50mA/step in current. In addition, cable-loss compensation and e-Marker detection are provided.

After the power negotiation is established, AP43781 can support DisplayPort™ by decoding out the CC signal and then deliver the routing control and signaling information to the high-speed switches and the re-driver/re-timer ICs through I2C interface, where the I2C bus can be assigned as master or slave, and GPIO pins can be programmed for different applications.

The AP43781 can offer comprehensive safety protection schemes, including overvoltage protection (OVP), undervoltage protection (UVP), overcurrent protection (OCP), short-circuit protection (SCP) and/or overtemperature protection (OTP).

A one-time programmable ROM is provided for main firmware, and a multi-time programmable ROM is provided for user configuration data.

## **Pin Assignments**



W-QFN4040-24 (Type A1)

### **Features**

- Compatible with USB PD Rev3.1 SPR
- Support Full Range of PPS 3.3V to 21V with Resolution of 20mV/Step in Voltage and 50mA/Step in Current.
- Support Type-C Alternative Mode for DisplayPort
- Built-in Regulator for CV and CC Control
- Support OVP/UVP/OCP/SCP/OTP with Auto Restart
- Support Power Saving Mode
- Driver for Output Enable nMOS Switch
- Support E-Marker Cable Detection
- Support I2C Interface with Master and Slave Flexibility
- Operating Voltage Range: 3.3V to 24V
- OTP (One-Time Programmable) for Main Firmware
- MTP (Multi-Time Programmable) for System Configuration
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

## **Applications**

- Monitors with Type-C ports
- TV power boards with Type-C ports

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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### **Typical Applications Circuit**

Virtual monitor with demo board

(12V~18V)

AC Adapter

The AP43781 not only supports USB PD power profile negotiation with the sink controller, but also provides the data link capability to the sink device. Figure 1 illustrates how the AP43781 of the CLM (Type-C-Link-to-Monitor) module is used to play as a PD power source controller with support for DisplayPort application.

When the Type-C attachment is completed between an active CLM module and the NB host, the power profile negotiation is started through the CC commands. After the negotiation is completed, the AP43781 will enable the buck-boost controller to provide the matched power to the NB host.

At the same time, the AP43781 plays as a data down-facing port, and enters the alternative mode support by decoding out the VDM (Vendor Defined Message) CC commands delivered from NB host side. The decoded information is then sent out through the I2C interface to the high-speed switches (i.e. PI3USB31531) and signaling chips (i.e. PI3DPX1207C), so that the data stream can be delivered from host side to the DisplayPort at the right routing path and with correct signaling accordingly.

#### **CLM** board USB 3.1 Device PI4IOE5V9554 USB Type-C<sup>®</sup> Power Source DFP (Down-Facing Port) USB 3.1 PD Charging (100W, 20V@5A) Data Transfer UFP (Up-Facing Port) USB Type-C Alternate Mode TX1 (DisplayPort) USB Lane 0-3 RX2 # USB 31 Gen 1 / Gen 2 Type-C Switch TX2 # Support Pin C. D and E Assignment PI3USB31531 SBU1 Standby Power < 20mWatt</p> Monitor AUX N SBU2 DP-DP DisplayPort E-Marker C-C

PD3.1 SPR Controller (AP43781)

Figure 1. The AP43781 Supports DP Alternative Mode for Data Link During the Power Sourcing



# **Pin Descriptions**

Pin Number	Pin Name	Function
1	ISENP	Input Current Sense Positive Node
2	OCDRV	CC/CV Output. Open-Drain Output for Optocoupler.
3	GND	Ground
4	SDA	GPIO/I2C Data
5	SCL	GPIO/I2C Clock
6	GPIO4	General-Purpose Input or Output
7	GPIO2	General-Purpose Input or Output
8	GPIO1	General-Purpose Input or Output
9	GPIO3	General-Purpose Input or Output
10	NC	No Connection
11	GPIO5	General-Purpose Input or Output
12	V3VD	LDO-3V Output
13	OTP	Source Current to External NTC Sensor for OTP (Overtemperature Protection). Current amplitude is programmable.
14	VFB	CV Input. Negative Node of CV OPAMP for Optocoupler.
15	IFB	CC Input. Negative Node of CC OPAMP for Optocoupler.
16	CC2	Type-C_CC2
17	CC1	Type-C_CC1
18	DN	Type-C_DN
19	DP	Type-C_DP
20	V5V	LDO-5V Output, Connected to a Decoupling Capacitor.
21	NC	No Connection
22	VBUS	Output Terminal for Discharge Path
23	PWR_EN	External nMOS Gate Driver. To control external MOS switch, 1: To enable VBUS voltage.  0: Disconnect VBUS.
24	VCC	The Power Supply of The IC, Connected to a Ceramic Capacitor.

Table 1. The AP43781 Pinout Description



## **Functional Block Diagram**

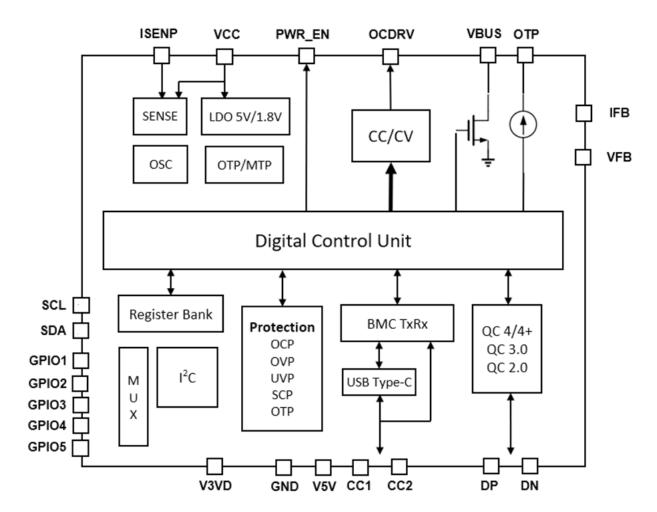


Figure 2. The AP43781 Block Diagram



## **Absolute Maximum Ratings** (Note 4)

Symbol	Parameter	Rating		Unit
Vvcc	Input Voltage at VCC Pin -0.3 to 24			V
V <sub>VFB</sub> , V <sub>IFB</sub> , V <sub>OTP</sub>	Input Voltage at VFB, IFB, OTP Pins	-0.3 to 7		V
VVBUS, VPWR_EN, VISENP, VOCDRV	Input Voltage at VBUS, PWR_EN, ISENP, OCDRV Pins	-0.3 to 24		V
_	Voltage from PWR_EN to VCC Pin	-16 to 7		V
V <sub>V5V</sub>	Input Voltage at V5V Pin	-0.3 to 7		V
VCC1, VCC2	Input Voltage at CC1, CC2 Pins	-0.3 to 7		V
V <sub>DP</sub> , V <sub>DN</sub>	Input Voltage at DP, DN Pins	-0.3 to 7		V
V <sub>GPIO1</sub> - V <sub>GPIO5</sub> , V <sub>SDA</sub> , V <sub>SCL</sub> Input Voltage at GPIO1-5, SDA, SCL Pins (Note 5)		-0.3 to 5	-0.3 to 5	
TJ	Operating Junction Temperature	-40 to +150		°C
T <sub>STG</sub>	Storage Temperature -65 to +150			°C
T <sub>LEAD</sub> Lead Temperature (Soldering, 10s)		+300		°C
θμΑ	Thermal Resistance (Junction to Ambient) (Note 6)	W-QFN4040-24 (Type A1)	28	°C/W
θ <sub>JC</sub> Thermal Resistance (Junction to Case) (Note 6)		W-QFN4040-24 (Type A1)	16	°C/W
_	ESD (Human Body Model) Voltage on DP, DN Pins	6		kV
_	ESD (Human Body Model) Voltage on VBUS, ISENP, PWR_EN, VCC, OCDRV, OTP, V5V, IFB, VFB, CC1, CC2 Pins	2		kV
	ESD (Charged Device Model)	750		V

Notes:

- 4. Stresses greater than those listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only, and 4. Stesses greater than inlose listed under *Absolute Maximum Ratings* can cause permitted under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.

  5. When GPIO1-5, SDA, and SCL pins are pulled high to a voltage source, it is strongly recommended to series a resistor with minimum 10k value.

  6. Test condition: device mounted on FR-4 substrate PC board, 2oz copper, with the minimum footprint.

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
Vvcc	Power Supply Voltage	3.3	24	V
Тор	Operating Temperature Range	-40	+85	°C



## **Electrical Characteristics** (@TA = +25°C, unless otherwise specified.)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
VCC PIN SECTION						
V <sub>ST</sub> Startup Voltage -		_	2.5	2.8	3.2	V
V <sub>UVLO</sub> Minimum Operating Voltage		_	2.4	2.7	3	V
Vvcc_hys	Vvcc Hysteresis (VsT-VuvLo)	_	0.05	_	_	V
IVCC_DEEP SLEEP	V <sub>IN</sub> Current in Deep Sleep Mode	CC1/2 Detach after 3s Vvcc = 5V	_	550	900	μΑ
I <sub>VCC_OPR</sub>	Operating Supply Current	V <sub>VCC</sub> = 5V	_	3.3	6	mA
VOLTAGE CONTROL	LOOP SECTION					
VREF_CV5	Reference Voltage for 5V CV Control	_	4.85	5	5.15	V
VREF_CV9	Reference Voltage for 9V CV Control	_	8.73	9	9.27	V
VREF_CV12	Reference Voltage for 12V CV Control	_	11.64	12	12.36	V
VCABLE	Cable Compensation (Note 7)	_	22	32	42	mV/A
los	Maximum OCDRV Pin Sink Current	Vout = 5V	10	16	30	mA
PROTECTION FUNCT	TON SECTION		•		•	
V <sub>O</sub> VP5V	OVP_5V Enable Voltage (Note 8)	_	5.6	6	6.8	V
V <sub>OVP9V</sub>	OVP_9V Enable Voltage (Note 8)	_	9.9	10.8	12.1	V
Vovp12V	OVP_12V Enable Voltage (Note 8)	_	13.2	14.4	16.2	V
tdebounce_ovp	OVP Debounce Time (Note 9)	_	_	90	_	ms
V <sub>UVP5V</sub> UVP_5V Enable Voltage		_	3.3	3.7	4.4	V
Vuvp9v	UVP_9V Enable Voltage	_	5.9	6.8	7.7	V
V <sub>UVP12V</sub>	UVP_12V Enable Voltage	_	7.9	9.1	10	V
I <sub>OVD</sub> Overvoltage Discharge Current		Vvcc = 5V	150	200	250	mA
tocp	OCP Deglitch Time (Note 10)	_	_	30	_	ms
trestart_interval_scp	Restart Interval Time under SCP (Note 10)	_	_	0.8	_	S
Тотр	Internal OTP Temperature (Note 10)	_	_	+140	_	°C
I <sub>OTP_EXTERNAL</sub>	External OTP Current	_	90	100	110	μA
Thys	OTP Recovery Hysteresis Temperature (Note 10)	_	_	+25	_	°C
tsleep	Enter Sleep Mode Time after Cable Detached (Note 10)	_	_	3	_	s
tov_delay	Delay from OVP Threshold Trip to nMOS Gate Turn-Off (Note 10)	_	_	_	50	μs
Delay from UVP Threshold Trip to nMOS Gate Turn-Off (Note 10)		_	_	30	_	ms
CC1/CC2, DP/DN PIN			_		_	
V <sub>L_RD3A</sub>	Low Voltage Threshold Used to Distinguish RD Attached or Detached for 3A Delivery	_	_	1.35	_	V
V <sub>H_RD3A</sub>	High Voltage Threshold Used to Distinguish R <sub>D</sub> Attached or Detached for 3A Delivery	_	_	2.0	_	V
lrdза	CC1/CC2 Current Source for 3A Advertisement	V <sub>VCC</sub> = 5V	304	330	356	μΑ
V <sub>OVP_DN</sub>	DN Line Overvoltage Protection Threshold	_	4.1	4.5	4.8	V
$V_{OVP\_DP}$	DP Line Overvoltage Protection Threshold	_	4.1	4.5	4.8	V

Notes:

<sup>7.</sup> Cable compensation voltage can be adjusted by setting from 0 to  $V_{CABLE \, {}^{\star} \, N}$  (N: 0 to 7).

<sup>8. 120%</sup> OVP setting & 76% UVP setting.

9. OVP blanking time during V<sub>O</sub> transition from high output voltage to low output voltage, such as 9V to 5V, or 12V to 5V.

10. Guaranteed by design.



### **Performance Characteristics**

#### System Power-On Sequence

Once external power is supplied to the VCC pin, the AP43781 will wake up. All analog control blocks will get ready, and then the digital block and MCU engine will start initialization flow. After the power-on initialization, the system closed loop is established by the AP43781 and the power module is ready for the Type-C PD negotiation process.

### **Cable Attachment and Power On Initialization**

Once the Type-C cable is plugged into the NB or the sink device from the powered PD source, the Rd on the sink side will pull down one of the CC1/CC2 channel to establish a CC routing path, and then the CC/VCONN configuration is completed. After the cable attachment, the source adapter enables VBUS with 5V, and starts VCONN power supply to enable cable e-Marker to check its current handling capability. After that, the PD source adapter starts broadcasting PD source capabilities to the PD sink through CC pin. Meanwhile, the NB or the sink device can decode the CC packet to get the source capability, and then starts a PD negotiation process to request the PD source to output a suitable power profile.

#### **Voltage Transition**

When the sink and source make an acceptable power request deal, the AP43781 will provide the VBUS with the requested voltage and current capability through the VFB control feedback or I2C communication to the DC/DC controller. During the voltage transition, the feedback system stability of AP43781 and DC/DC controller should be carefully designed to guarantee monotonic voltage transition and avoid violating USB PD electrical specification.

#### **DisplayPort Alternate Mode Support**

After the PDO negotiation is completed, the AP43781 plays as a data Upstream Facing Port (UFP), and enter the alternative mode support by decoding out the VDM (Vendor Defined Message) commands delivered by the host side. The AP43781 supports DisplayPort Alternate Mode on USB Type-C standard with Discover Identify, Discover SVIDs, Discover Modes, Enter Mode, DP Status, DP Configure, and Exit Mode. The decoded information is then sent out to the high-speed switches (i.e. PI3USB31531) and signaling chips (i.e. PI3DPX1207C) through the I2C interface, so that the data stream can be delivered from host side to the DisplayPort at the right routing path and correct signaling accordingly.

#### CV/CC

The AP43781 supports Constant Voltage (CV) and Constant Current (CC) functions to control the output voltage and the output current by the control pin OCDRV. During the CV mode, the AP43781 operates in fixed PDO, and the output voltage will be regulated to the request voltage if the output current is below the allowed maximum current. Once the sink device draws more than IoCP, the overcurrent protection occurs. When the CC mode function is enabled, the output voltage drops, and the source current is limited within 150mA whenever output current exceeds the allowed maximum current. When the output voltage drops below UVP, the constant current limit turns off VBUs and starts error recovery procedure. The AP43781 will reset if the voltage continues dropping to the UVLO threshold.

#### Protection

The AP43781 provides OVP/UVP/OCP/SCP/OTP functions and supports Constant Current (CC) function. All of the protection thresholds depend on the requested power profile, and provide the most reliable protection scheme.

The AP43781 provides OVP feature by turning off the power switch when V<sub>BUS</sub> is higher than OVP enable voltage. Meanwhile, it provides an internal discharge path to reduce the overvoltage duration, and terminates discharge current as soon as V<sub>BUS</sub> reaches the target voltage. To prevent the VBUS pin from working abnormally, the AP43781 provides UVP function whenever V<sub>BUS</sub> drops to UVP enable voltage.

To ensure the safe operation of USB PD, the AP43781 provides programmable OCP function to make sure output current will not be higher than the allowed maximum current. Once OCP conditions happen, the AP43781 will shut down the USB PD system and send "Hard Reset" to the host side.

#### MCU and OTP/MTP ROM

The AP43781 has an MCU subsystem, which integrates an 8-bit 8051 processor, SRAM, and OTP ROM. The MCU subsystem is optimized for user configurability of different topologies, supporting different protocols, and low-power consumption at a low cost. With the embedded hardware PHY transceivers offloading MCU processing, the AP43781 can handle PD handshakes efficiently, and be compliant with critical USB Power Delivery specifications.

An OTP ROM is provided to store PD, QC, and FCP protocol firmware, and an MTP ROM is provided for user configuration table. Either in-system programming or offline socket programming are provided for the OTP ROM and MTP ROM.



### **Performance Characteristics** (continued)

#### **I2C Interface**

The I2C interface pins (SCK, SDA), as shown in below Table 2, are used to communicate between the PD decoder and DC/DC controller/converter to replace analog signal feedback of VFB with much higher noise immunity. I2C commands are supported by firmware so that it can monitors and changes status of other I2C devices

Pin No.	Pin Name	Pin Function
4	SDA	I2C Data
5	SCL	I2C Clock

Table 2. I2C Interface of the AP43781 Supports Both Master and Slave Modes

The AP43871 can play as an I2C master or slave device. The I2C read and write operations are supported as below.

All transactions begin with a START (S) and be terminated by a STOP (P). A START condition is defined whenever a HIGH to LOW transition on the SDA while SCL is HIGH. A STOP condition is defined whenever a LOW to HIGH transition on the SDA while SCL is HIGH. The START and STOP conditions are always generated by the master.

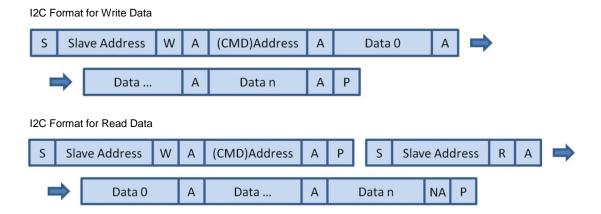
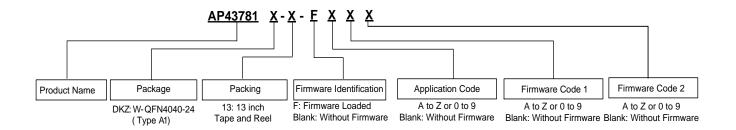


Figure 3. The I2C Command Format in AP43781



## **Ordering Information**



Part Number	Dookers	Identification Code	Packing		
Part Number	Package	Identification Code	Qty.	Carrier	
AP43781DKZ-13-FXXX	W-QFN4040-24 (Type A1)	6K	3000	13" Tape and Reel	

## **Marking Information**

### W-QFN4040-24 (Type A1)

## (Top View)



6K : Identification Code

 $\underline{Y}$ : Year: 0 to 9 (ex: 3 = 2023)  $\underline{W}$ : Week: A to Z: week 1 to 26;

a to z : week 27 to 52; z represents

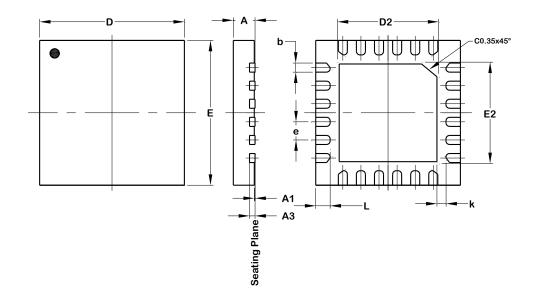
week 52 and 53  $\underline{X}$ : Internal Code



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### W-QFN4040-24 (Type A1)

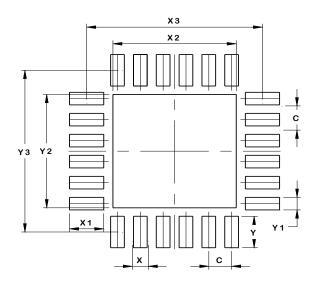


W-QFN4040-24				
	(Type A1)			
Dim	Min	Max	Тур	
Α	0.70	0.80	0.75	
A1	0.00	0.05	0.02	
A3	0	.203 R	EF	
b	0.18	0.30	0.25	
D	4.00 BSC			
D2	2.65	2.75	2.70	
Е	4.00 BSC			
E2	2.65	2.75	2.70	
е	0.50 BSC			
k	0.20			
L	0.35	0.45	0.40	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### W-QFN4040-24 (Type A1)



Dimensions	Value (in mm)	
С	0.500	
Х	0.300	
X1	0.750	
X2	2.700	
Х3	3.850	
Υ	0.750	
Y1	0.300	
Y2	2.700	
Y3	3.850	

### **Mechanical Data**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per J-STD-202 @3
- Weight: 0.041 grams (Approximate)



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